Read-Write Memories (RAM)

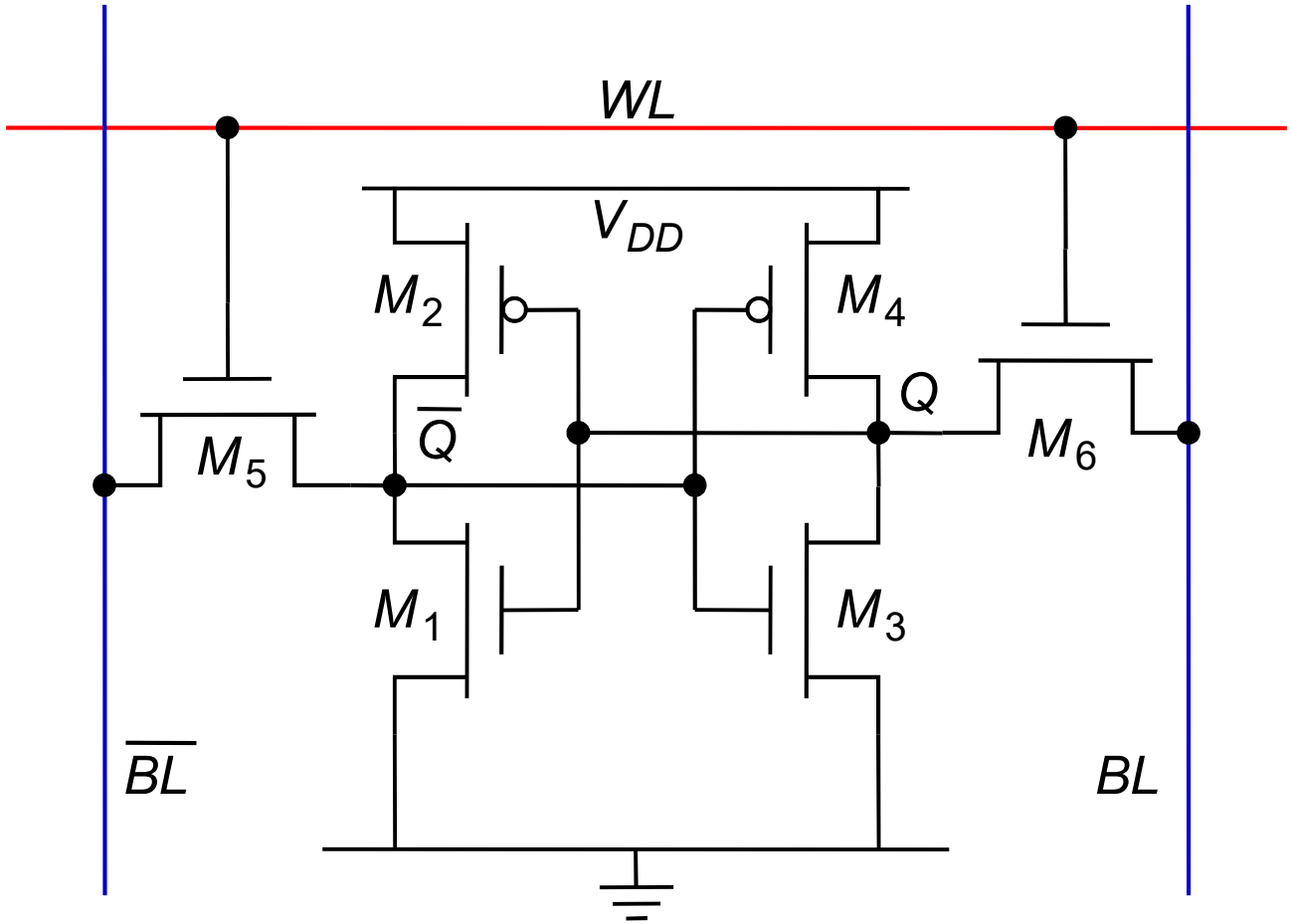
❑ STATIC (SRAM)

Data stored as long as supply is applied
Large (6 transistors/cell)
Fast
Differential

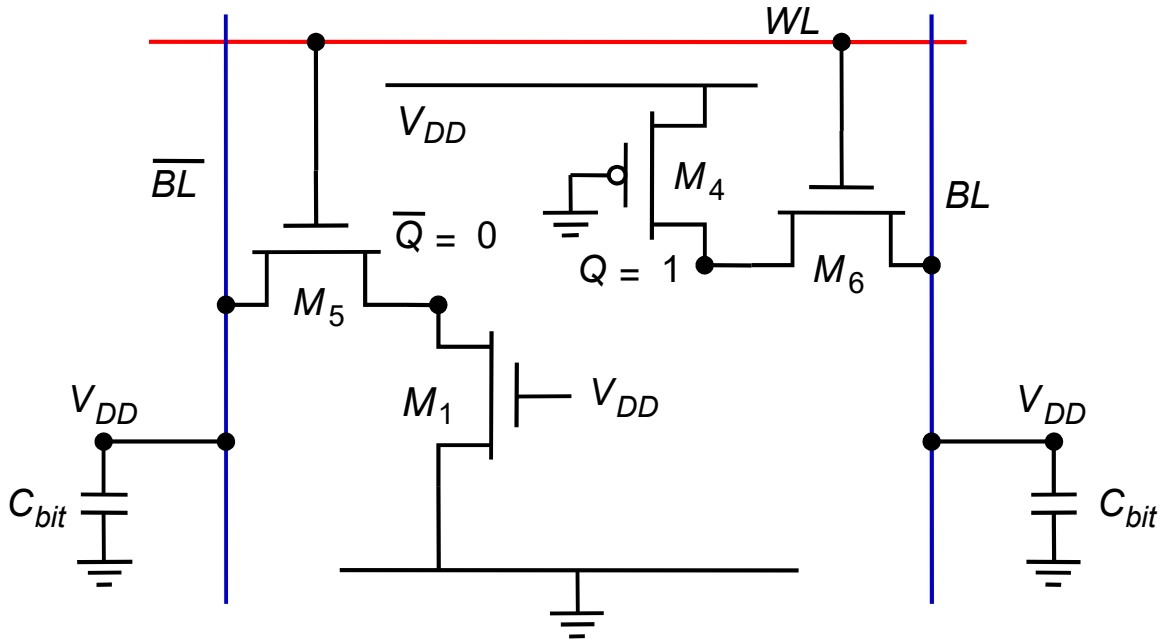
❑ DYNAMIC (DRAM)

Periodic refresh required
Small (1-3 transistors/cell)
Slower
Single Ended

6-transistor CMOS SRAM Cell



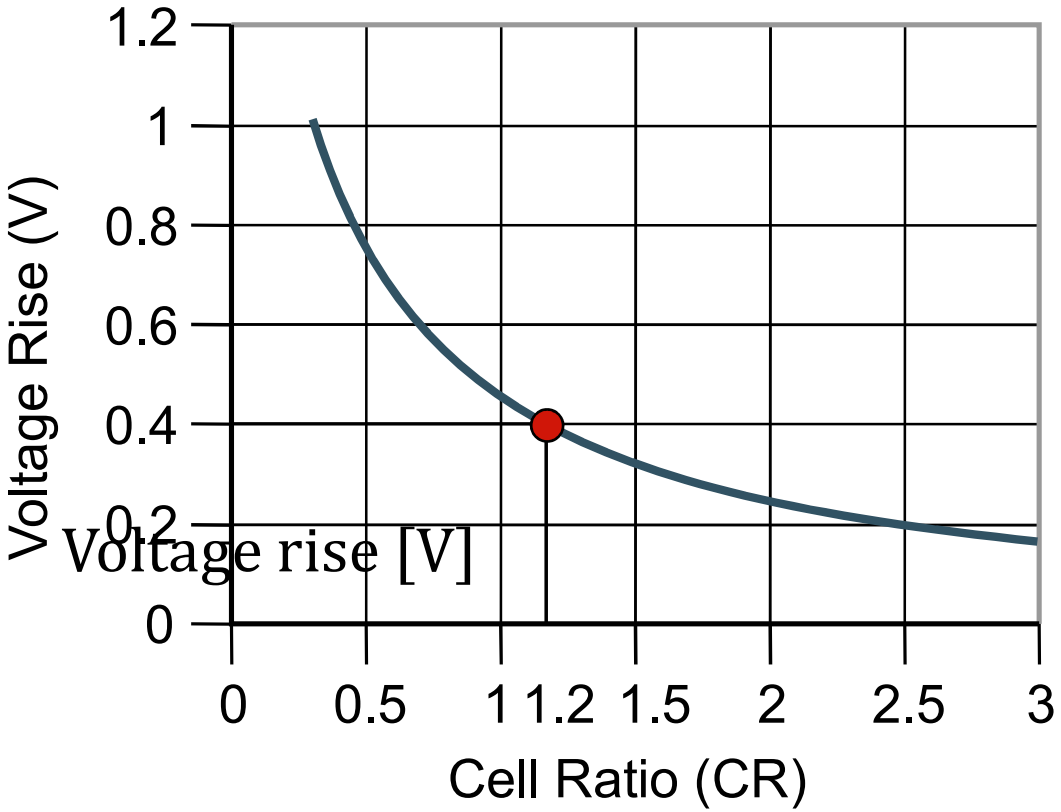
CMOS SRAM Analysis (Read)



$$k_{n,M5}\left((V_{DD}-\Delta V-V_{Tn})V_{DSATn}-\frac{V_{DSATn}^2}{2}\right)=k_{n,M1}\left((V_{DD}-V_{Tn})\Delta V-\frac{\Delta V^2}{2}\right)$$

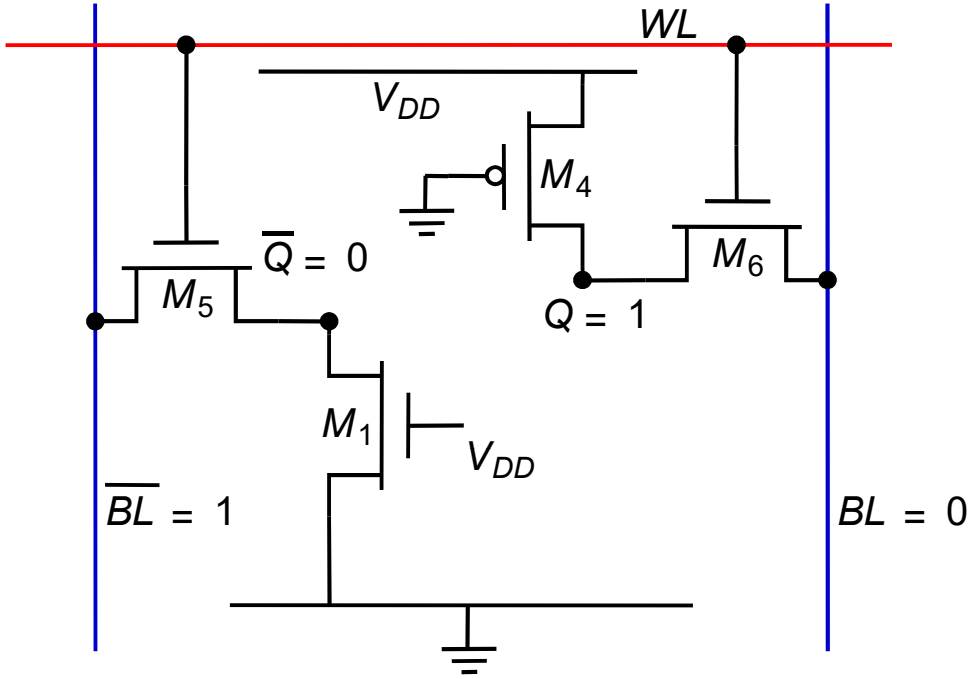
$$\Delta V=\frac{V_{DSATn}+CR(V_{DD}-V_{Tn})-\sqrt{V_{DSATn}^2(1+CR)+CR^2(V_{DD}-V_{Tn})^2}}{CR}$$

CMOS SRAM Analysis (Read)



$$CR = \frac{W_1/L_1}{W_5/L_5}$$

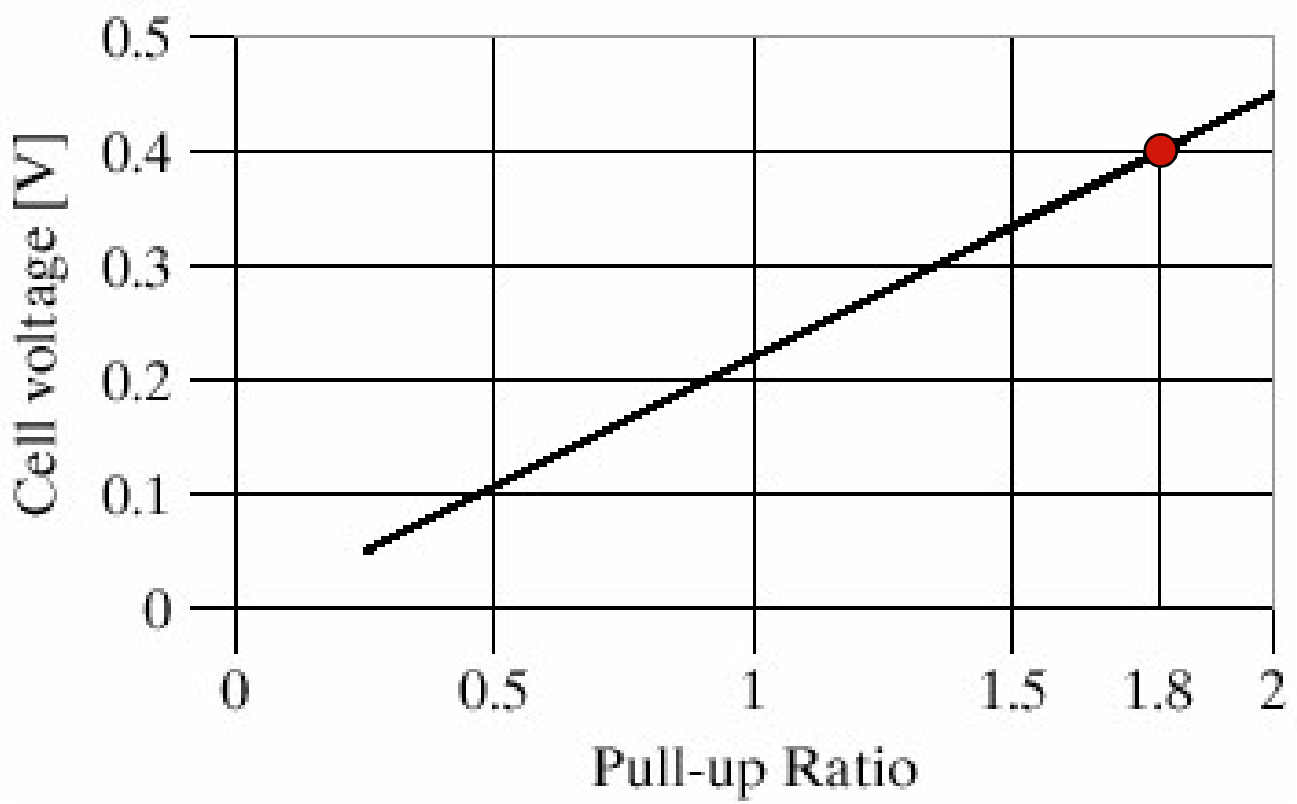
CMOS SRAM Analysis (Write)



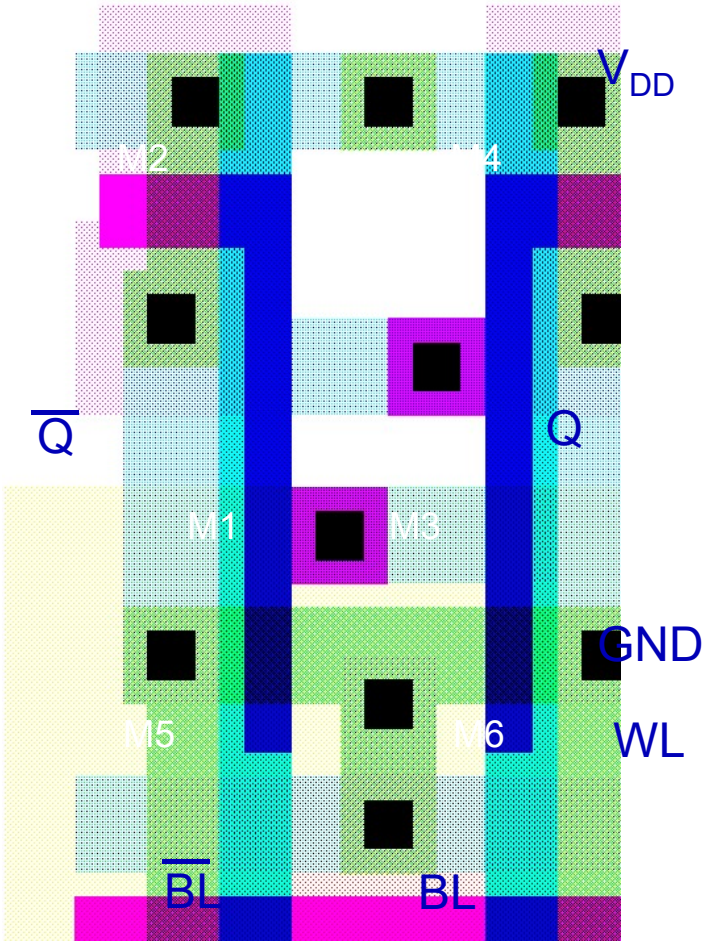
$$k_{n,M6}\left((V_{DD}-V_{Tn})V_Q-\frac{V_Q^2}{2}\right)=k_{p,M4}\left((V_{DD}-|V_{Tp}|)V_{DSATp}-\frac{V_{DSATp}^2}{2}\right)$$

$$V_Q = V_{DD}-V_{Tn}-\sqrt{(V_{DD}-V_{Tn})^2-2\frac{\mu_p}{\mu_n}PR\left((V_{DD}-|V_{Tp}|)V_{DSATp}-\frac{V_{DSATp}^2}{2}\right)},$$

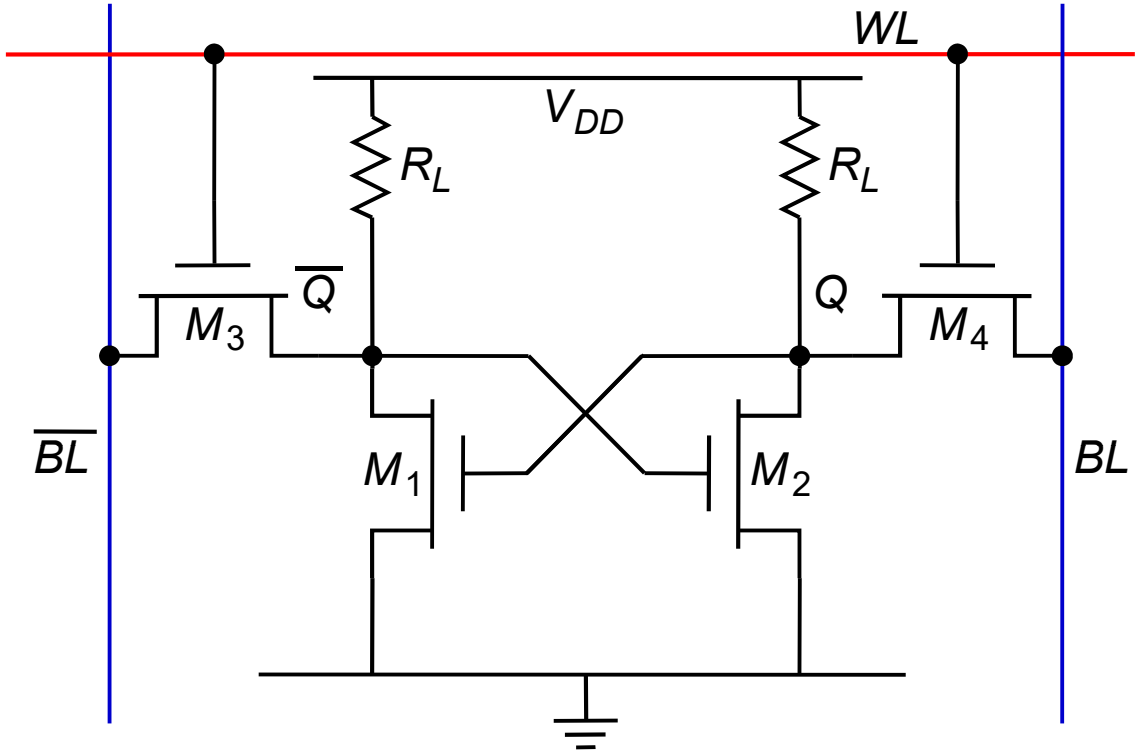
CMOS SRAM Analysis (Write)



6T-SRAM — Layout



Resistance-load SRAM Cell



Static power dissipation -- Want R_L large
Bit lines precharged to V_{DD} to address t_p problem

SRAM Characteristics

Table 12-2 Comparison of CMOS SRAM cells used in 1-Mbit memory (from [Takada91])

	Complementary CMOS	Resistive Load	TFT Cell
Number of transistors	6	4	4 (+2 TFT)
Cell size	58.2 μm^2 (0.7-μm rule)	40.8 μm^2 (0.7-μm rule)	41.1 μm^2 (0.8-μm rule)
Standby current (per cell)	10^{-15} A	10^{-12} A	10^{-13} A